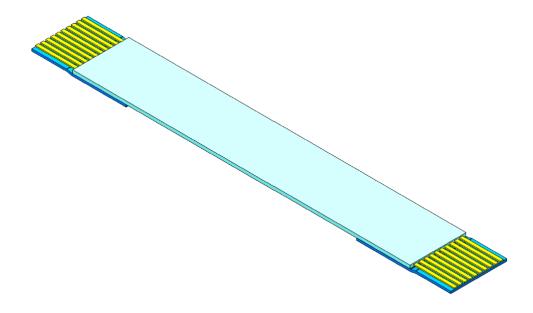


FJH Series - Double End



Other configurations available for:

Horizontal Orientation, Contact top, Contact bottom

See <u>www.samtec.com</u> for more information.



1.0 SCOPE

1.1 This specification covers performance, testing and quality requirements for Samtec ZF5S/FJH Series 0,50 mm (.0197") Zero Insertion Force Flat Flexible Cable (FFC) Connector/Jumper. All information contained in this specification is for a Horizontal Orientation, Contact bottom configuration unless otherwise noted.

2.0 DETAILED INFORMATION

2.1 Product prints, footprints, catalog pages, test reports and other specific, detailed information can be found at www.samtec.com/zroducts/fjh

3.0 TESTING

3.1 Current Rating: 1.8 A (One pin powered per row)

3.2 Voltage Rating: 195 VAC

3.3 Operating Temperature Range: -55°C to +80°C

3.4 Operating Humidity Range: 90% to 95% (Per EIA-364-31)

3.5 Electrical:

ITEM	TEST CONDITION	REQUIREMENT	STATUS
Withstanding Voltage	EIA-364-20 (No Flashover, Sparkover, or Breakdown)	585 VAC	Pass
Insulation Resistance	EIA-364-21 (1000 MΩ minimum)	1,000 ΜΩ	Pass
Contact Resistance (LLCR)	EIA-364-23	Δ 15 m Ω maximum (Samtec defined)/ No damage	Pass

3.6 Mechanical:

ITEM	TEST CONDITION REQUIREMENT		STATUS	
Durability EIA-364-09C		30 cycles	Pass	
	EIA-364-28 Condition V, Letter B	B Condition V, Letter B Visual Inspection: No Damage		
Random Vibration	7.56 G 'RMS', 50 to 2000 Hz, 2	LLCR: Δ 15 mΩ maximum	Pass	
Kandom vibration	hours per axis, 3 axis total, PSD	Event Detection: No interruption >		
	0.04	50 nanoseconds		
	EIA-364-27 100 G, 6	Visual Inspection: No Damage		
Mechanical Shock	milliseconds, sawtooth wave,	LLCR: Δ 15 mΩ maximum	Pass	
IVIECHAINCAI SHOCK	11.3 fps, 3 shocks/direction, 3	Event Detection: No interruption >		
	axis (18 total shocks)	50 nanoseconds		
Normal Force	EIA-364-04	100 grams minimum for tin	Pass	
Normal Force	EIA-304-04	interface	F a 5 5	

ITEM	REQUIREMENT
Engage force of cam	150 g/circuit
Force to remove flex with closed cam	48 g/circuit

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3.7 Environmental:

ITEM	TEST CONDITION	REQUIREMENT	STATUS
Thermal Shock	EIA-364-32 Thermal Cycles: 100 (30 minute dwell) Hot Temp: 85°C Cold Temp: -55°C Hot/Cold Transition: Immediate	Visual Inspection: No Damage LLCR: Δ 15 m Ω DWV: 585 VAC IR: >45,000 M Ω	Pass
Thermal Aging (Temp Life)	EIA-364-17 Test Condition 4 @ 105°C Condition B for 250 hours	Visual Inspection: No Damage LLCR: Δ 15 m Ω DWV: 585 VAC IR: >45,000 M Ω	Pass
Cyclic Humidity	EIA-364-31 Test Temp: 25°C to 65°C Relative Humidity: 90 to 95% Test Duration: 240 hours	Visual Inspection: No Damage LLCR: Δ 15 m Ω DWV: 585 VAC IR: >45,000 M Ω	Pass
Gas Tight EIA-364-36 Gas Exposure: Nitric Acid Vapor Duration: 60 min. Drying Temp.: 50°C +/- 3°C Measurements: Within 1 hour of Exposure		LLCR: Δ 15 mΩ	Pass

4.0 MATED SYSTEM

Mated view information can be found at link below:

http://www.samtec.com/documents/webfiles/cpdf/ZF5S%20Mated%20Document-MKT.pdf

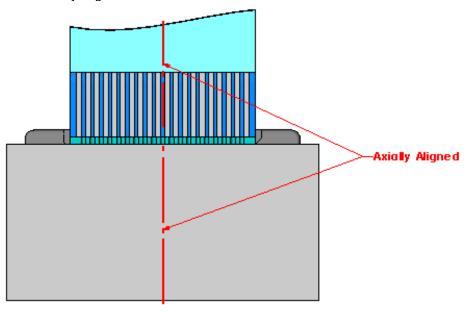
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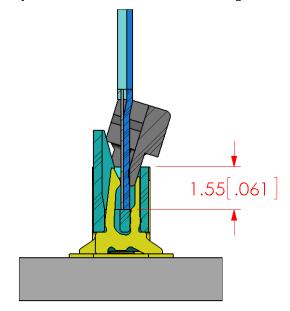
5.0 PROCESSING RECOMMENDATIONS

5.1 Mating Alignment Requirements:

5.1.1 Cable must be axially aligned to connector when mated and un-mated.

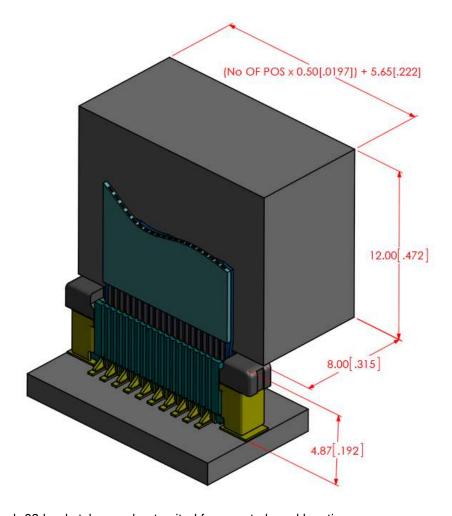


5.1.2 Cable must be fully inserted to connector before closing the cam.

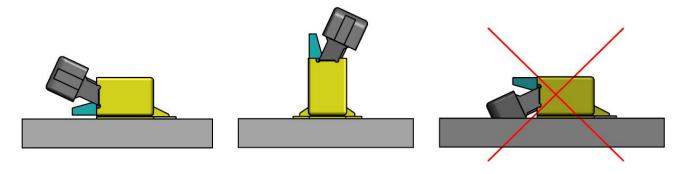




5.1.3 We recommend to use a flat bar tool for closing the cam, especially for 40 and above positions Counts.

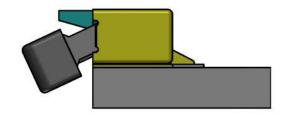


5.1.4 The -01 and -03 lead styles are best suited for remote board locations.

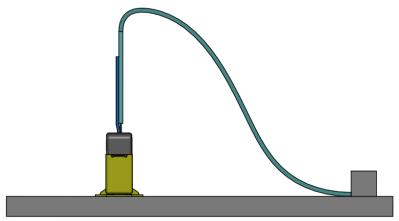




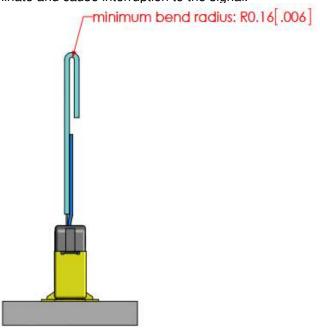
5.1.5 The -02 lead style is best suited for edge of the board locations.



5.1.6 Flex jumpers longer than 3 inches should be secured to prevent excessive stress on the ZF5S Connector.



5.1.7 The minimum bend radius is R0.16 [.006]. We recommend that the cable should not be bent in the vicinity of the stiffener. If it is bent in this area, there is a potential to cause the leads to break/delaminate and cause interruption to the signal.



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6.1 Due to variances in equipment, solder pastes and applications (board design, component density, etc.), Samtec does not specify a recommended reflow profile for our connectors. The processing parameters provided by the solder paste manufacturer should be employed and can usually be found on their website.

All of Samtec's surface mount components are lead free reflow compatible and compliant with the profile parameters detailed in IPC/JEDEC J-STD-020 which requires that components be capable of withstanding a peak temperature of 260°C as well as 30 seconds above 255°C.

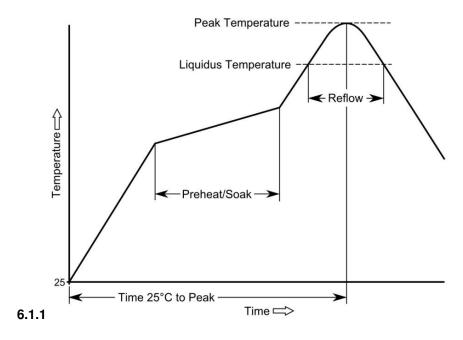
Samtec Recommended Temperature Profile Ranges (SMT)

Sn-Pb Eutectic Assembly

Preheat/Soak (100°C-150°C)	Max Ramp Up Rate	Reflow Time (above 183°C)	Peak Temp	Time within 5°C of 235°C	Max Ramp Down Rate	Time 25°C to Peak Temp
60-120 sec.	3°C/s max.	40-150 sec.	235°C	20 sec. max.	6°C/s max.	6 min. max.

Pb-Free Assembly

Preheat/Soak (150°C-200°C)	Max Ramp Up Rate	Reflow Time (above 217°C)	Peak Temp	Time within 5°C of 260°C	Max Ramp Down Rate	Time 25°C to Peak Temp
60-120 sec.	3°C/s max.	40-150 sec.	260°C	30 sec. max.	6°C/s max.	8 min. max.



These guidelines should not be considered design requirements for all applications. Samtec recommends testing interconnects on your boards in your process to guarantee optimum results.

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- **6.2 Maximum Reflow Passes:** The parts can withstand three reflow passes at a maximum component temperature of 260°C.
- **6.3 Stencil Thickness:** The recommended stencil thickness is .005" (0,13 mm).
- **6.4 Placement:** Machine placement of the parts is strongly recommended.
- **6.5 Reflow Environment:** Samtec recommends the use of a low level oxygen environment (typically achieved through Nitrogen gas infusion) in the reflow process to improve solderability.
- **6.6 Cleaning:** Samtec, Inc. has verified that our connectors may be cleaned in accordance with the solvents and conditions designated in the EIA-364-11 standard.

7.0 ADDITIONAL RESOURCES

- **7.1** For additional mechanical testing or product information, contact our Customer Engineering Support Group at CES@samtec.com
- 7.2 For additional information on high speed performance testing, contact our Signal Integrity Group at SIG@samtec.com
- 7.3 For additional processing information, contact our Interconnect Processing Group at IPG@samtec.com.
- **7.4** For RoHS, REACH or other environmental compliance information, contact our Product Environmental Compliance Group at PEC@samtec.com

USE OF PRODUCT SPECIFICATION SHEET

This Product Specification Sheet ("PSS") is a brief summary of information related to the Product identified. As a summary, it should only be used for the limited purpose of considering the purchase/use of Product. For specific, detailed information, including but not limited to testing and Product footprint, refer to Section 2.0 of this document and the links there provided to test reports and prints. This PSS is the property of Samtec, Inc. ("Samtec") and contains proprietary information of Samtec, our various licensors, or both. Samtec does not grant express or implied rights or license under any patent, copyright, trademark or other proprietary rights and the use of the PSS for building, reverse engineering or replication is strictly prohibited. By using the PSS, the user agrees to not infringe, directly or indirectly, upon any intellectual property rights of Samtec and acknowledges that Samtec, our various licensors, or both own all intellectual property therein. The PSS is presented "AS IS". While Samtec makes every effort to present excellent information, the PSS is only provided as a guideline and does not, therefore, warrant it is without error or defect or that the PSS contains all necessary and/or relevant information about the Product. The user agrees that all access and use of the PSS is at its own risk. NO WARRANTIES EXPRESSED OR IMPLIED, INCLUDING ANY WARRANTY OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR OF ANY KIND WHATSOEVER ARE PROVIDED.

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